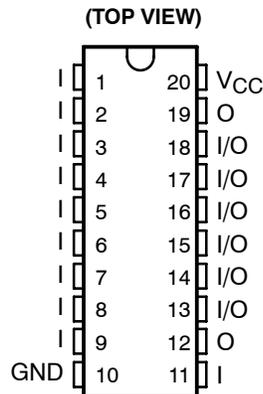# TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16L8-10M, TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS
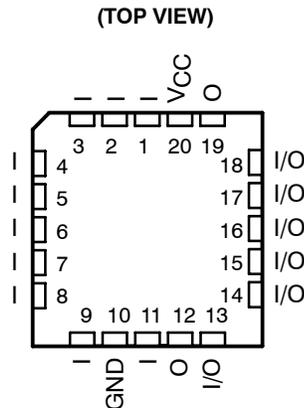
SRPS006E – D3115, MAY 1988 – REVISED DECEMBER 2010

- **High-Performance Operation:**
  f_{max} **(no feedback)**
    TIBPAL16R'-7C Series . . . 100 MHz Min
    TIBPAL16R'-10M Series . . . 62.5 MHz Min
  f_{max} **(internal feedback)**
    TIBPAL16R'-7C Series . . . 100 MHz Min
    TIBPAL16R'-10M Series . . . 62.5 MHz Min
  f_{max} **(external feedback)**
    TIBPAL16R'-7C Series . . . 74 MHz Min
    TIBPAL16R'-10M Series . . . 52.5 MHz Min
  Propagation Delay
    TIBPAL16L'-7C Series . . . 7 ns Max
    TIBPAL16L'-10M Series . . . 10 ns Max

- **Functionally Equivalent, but Faster than, Existing 20-Pin PLDs**

- **Preload Capability on Output Registers Simplifies Testing**

- **Power-Up Clear on Registered Devices (All Register Outputs are Set Low, but Voltage Levels at the Output Pins Go High)**

- **Package Options Include Both Plastic and Ceramic Chip Carriers in Addition to Plastic and Ceramic DIPs**

- **Security Fuse Prevents Duplication**

- **Dependable Texas Instruments Quality and Reliability**

TIBPAL16L8'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J PACKAGE

(TOP VIEW)

I	1	20	V_{CC}
I	2	19	O
I	3	18	I/O
I	4	17	I/O
I	5	16	I/O
I	6	15	I/O
I	7	14	I/O
I	8	13	I/O
I	9	12	O
GND	10	11	I

TIBPAL16L8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE

(TOP VIEW)

Pin assignments in operating mode

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORTS
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

description

These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT-X™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for futher reduction in board space.

All of the register outputs are set to a low level during power-up. Extra circuitry has been provided to allow loading of each register asynchronously to either a high or low state. This feature simplifies testing because the registers can be set to an initial state prior to executing the test sequence.

The TIBPAL16' C series is characterized from 0°C to 75°C. The TIBPAL16' M series is characterized for operation over the full military temperature range of –55°C to 125°C.

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PAL is a registered trademark of Advanced Micro Devices Inc.

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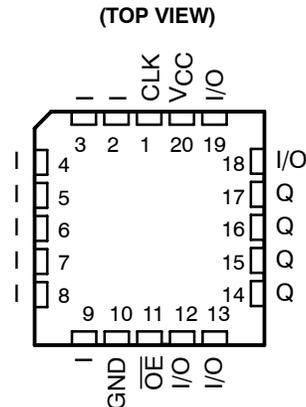
TEXAS INSTRUMENTS

TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS
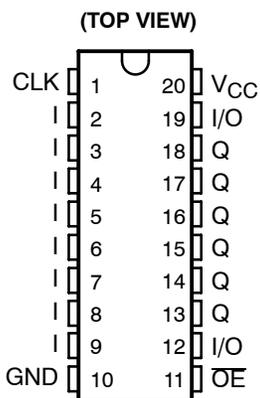
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TIBPAL16R4'
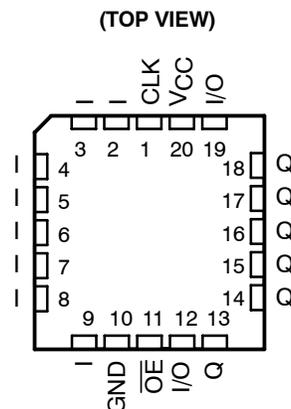**C SUFFIX . . . J OR N PACKAGE**
M SUFFIX . . . J PACKAGE

(TOP VIEW)

	Pin		Pin	
CLK	1		20	V_{CC}
I	2		19	I/O
I	3		18	I/O
I	4		17	Q
I	5		16	Q
I	6		15	Q
I	7		14	Q
I	8		13	I/O
I	9		12	I/O
GND	10		11	$\overline{OE}$

TIBPAL16R4'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE

(TOP VIEW)

Pins top (left to right): —, —, CLK, V_{CC}, I/O
Numbers: 3 2 1 20 19

Left	Pin	Right	Label
I	4	18	I/O
I	5	17	Q
I	6	16	Q
I	7	15	Q
I	8	14	Q

Bottom: 9 10 11 12 13
Bottom labels: —, GND, $\overline{OE}$, I/O, I/O

TIBPAL16R6'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J PACKAGE

(TOP VIEW)

	Pin		Pin	
CLK	1		20	V_{CC}
I	2		19	I/O
I	3		18	Q
I	4		17	Q
I	5		16	Q
I	6		15	Q
I	7		14	Q
I	8		13	Q
I	9		12	I/O
GND	10		11	$\overline{OE}$

TIBPAL16R6'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE

(TOP VIEW)

Pins top (left to right): —, —, CLK, V_{CC}, I/O
Numbers: 3 2 1 20 19

Left	Pin	Right	Label
I	4	18	Q
I	5	17	Q
I	6	16	Q
I	7	15	Q
I	8	14	Q

Bottom: 9 10 11 12 13
Bottom labels: —, GND, $\overline{OE}$, I/O, Q

TIBPAL16R8'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J PACKAGE

(TOP VIEW)

	Pin		Pin	
CLK	1		20	V_{CC}
I	2		19	Q
I	3		18	Q
I	4		17	Q
I	5		16	Q
I	6		15	Q
I	7		14	Q
I	8		13	Q
I	9		12	Q
GND	10		11	$\overline{OE}$

TIBPAL16R8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE

(TOP VIEW)

Pins top (left to right): —, —, CLK, V_{CC}, Q
Numbers: 3 2 1 20 19

Left	Pin	Right	Label
I	4	18	Q
I	5	17	Q
I	6	16	Q
I	7	15	Q
I	8	14	Q

Bottom: 9 10 11 12 13
Bottom labels: —, GND, $\overline{OE}$, Q, Q

Pin assignments in operating mode

TEXAS
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functional block diagrams (positive logic)

TIBPAL16L8'

TIBPAL16R4'

$\sim$ denotes fused inputs
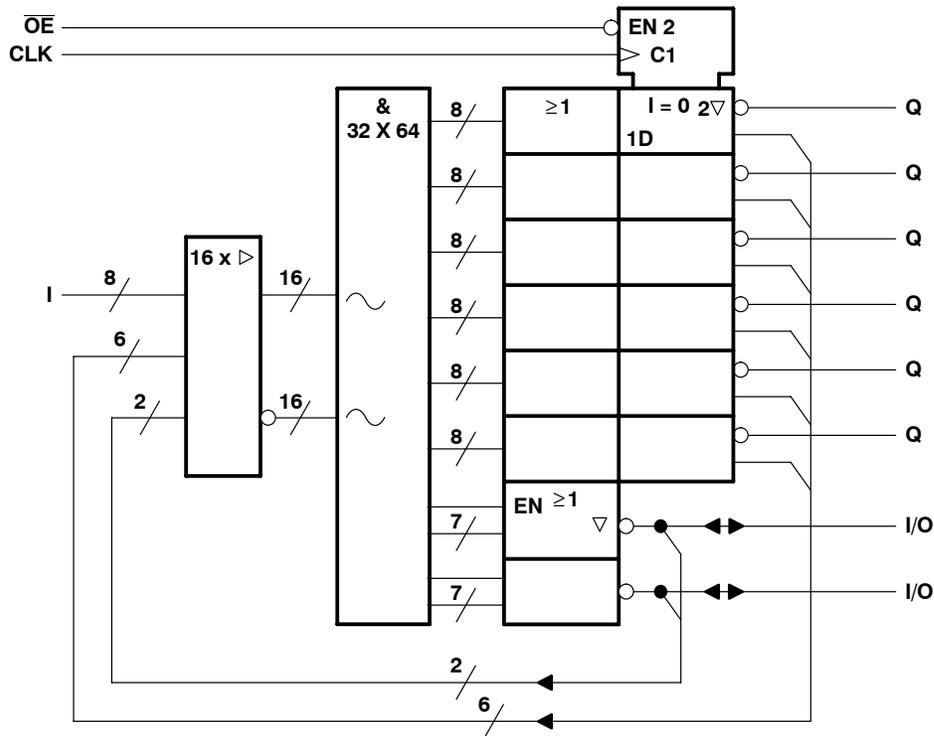
TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16R6-10M, TIBPAL16R8-10M
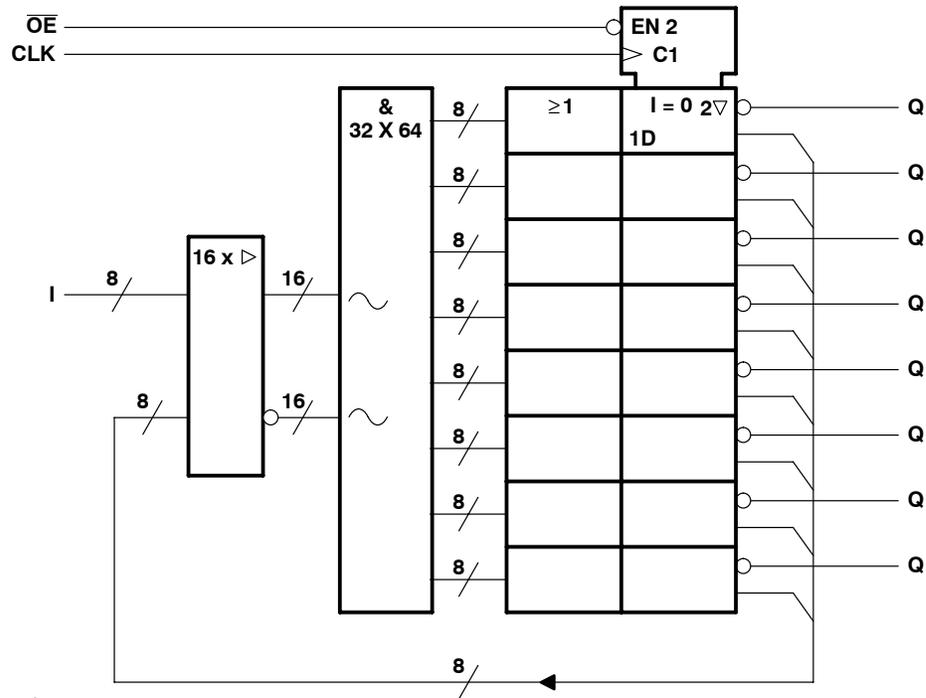## HIGH-PERFORMANCE *IMPACT-X* ™ *PAL*® CIRCUITS

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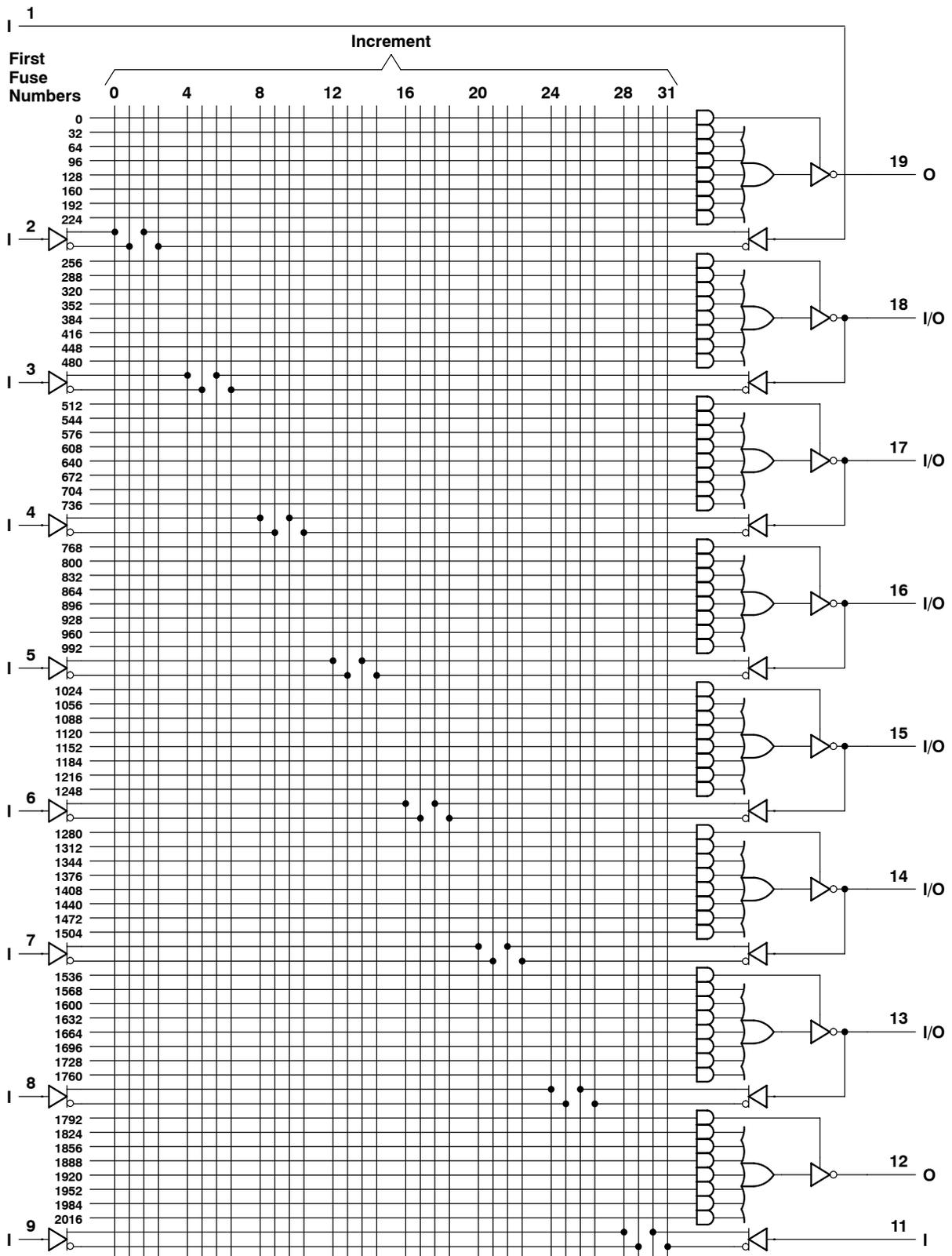## functional block diagrams (positive logic)

TIBPAL16R6'

TIBPAL16R8'

∿ denotes fused inputs

TEXAS INSTRUMENTS

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logic diagram (positive logic)

Fuse number = First fuse number + Increment

TIBPAL16R4-7C
TIBPAL16R4-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS

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logic diagram (positive logic)

Fuse number = First fuse number + Increment

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265
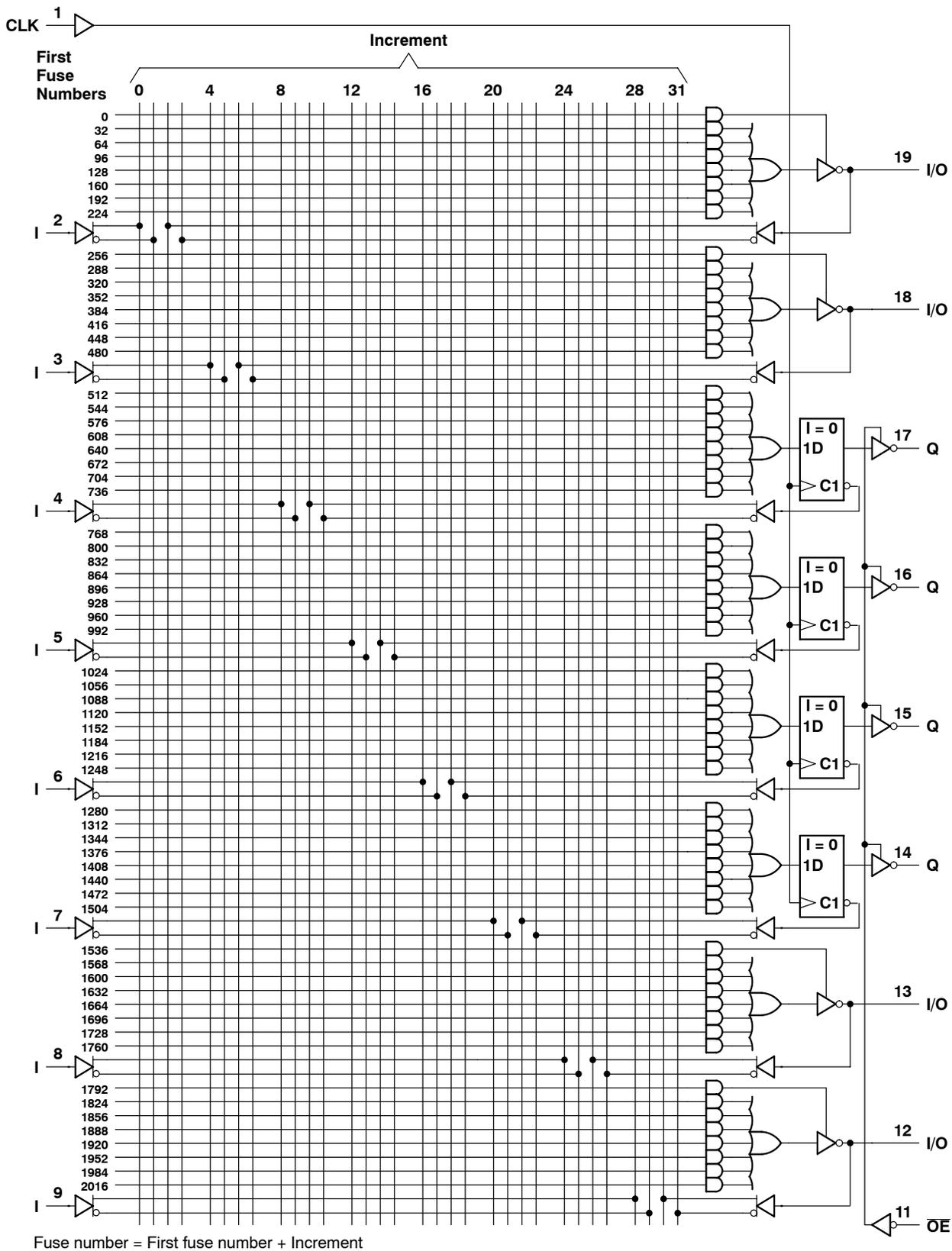
logic diagram (positive logic)

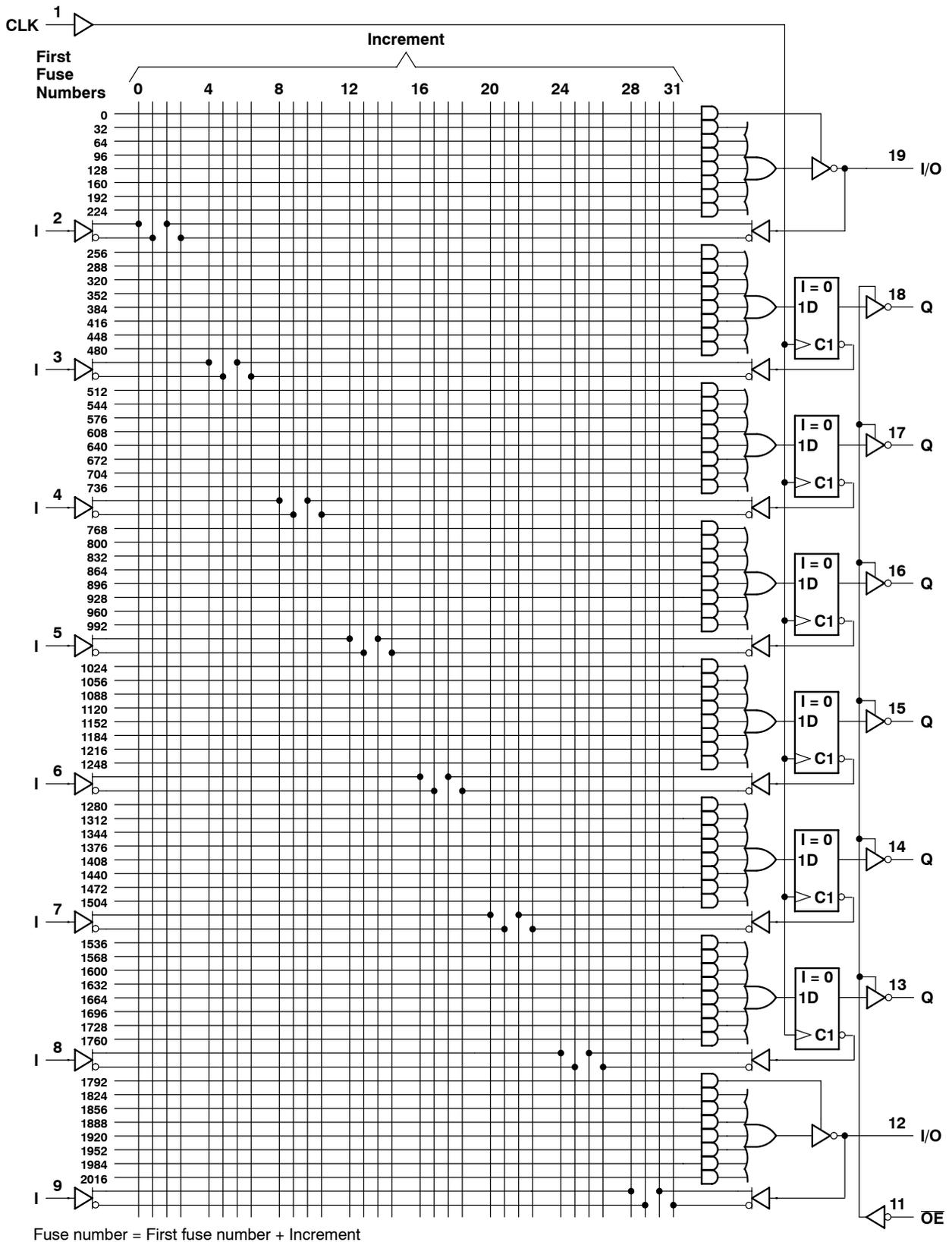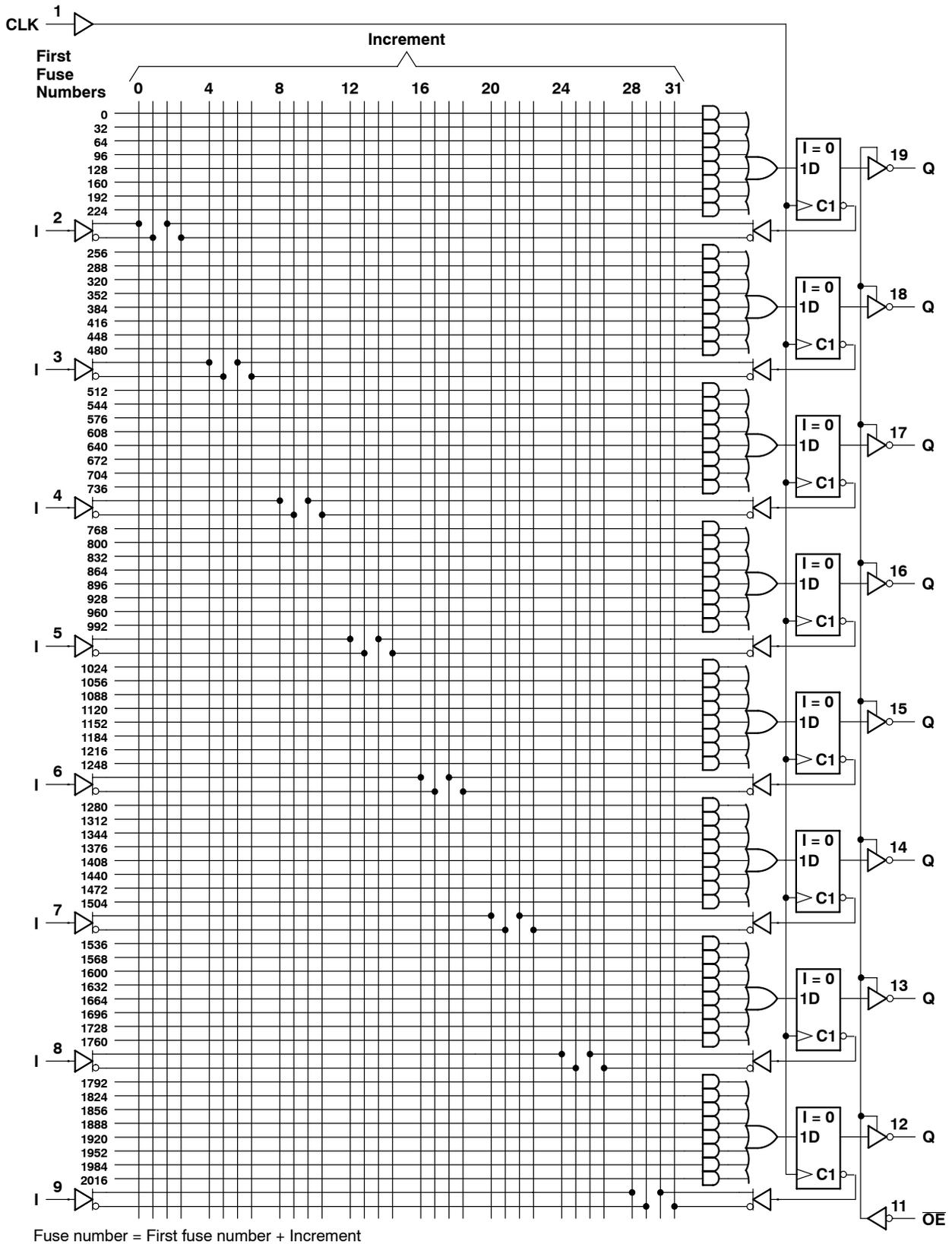Fuse number = First fuse number + Increment

TIBPAL16R8-7C
TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS

SRPS006E – D3115, MAY 1988 – REVISED DECEMBER 2010

logic diagram (positive logic)

Fuse number = First fuse number + Increment

TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL*® CIRCUITS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . 7 V
Input voltage (see Note 1) . . . . 5.5 V
Voltage applied to disabled output (see Note 1) . . . . 5.5 V
Operating free-air temperature range . . . . 0°C to 75°C
Storage temperature range . . . . −65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

				MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage			4.75	5	5.25	V
V_{IH}	High-level input voltage (see Note 2)			2		5.5	V
V_{IL}	Low-level input voltage (see Note 2)					0.8	V
I_{OH}	High-level output current					−3.2	mA
I_{OL}	Low-level output current					24	mA
f_{clock}	Clock frequency			0		100	MHz
t_w	Pulse duration, clock (see Note 2)	High		5			ns
		Low		5			
t_{su}	Setup time, input or feedback before clock↑			7			ns
t_h	Hold time, input or feedback after clock↑			0			ns
T_A	Operating free-air temperature			0	25	75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

electrical characteristics over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS			MIN	TYP[†]	MAX	UNIT
V_{IK}	V_{CC} = 4.75 V,	I_I = −18 mA			−0.8	−1.5	V
V_{OH}	V_{CC} = 4.75 V,	I_{OH} = −3.2 mA		2.4	3.2		V
V_{OL}	V_{CC} = 4.75 V,	I_{OL} = 24 mA			0.3	0.5	V
I_{OZH}[‡]	V_{CC} = 5.25 V,	V_O = 2.7 V				100	µA
I_{OZL}[‡]	V_{CC} = 5.25 V,	V_O = 0.4 V				−100	µA
I_I	V_{CC} = 5.25 V,	V_I = 5.5 V				100	µA
I_{IH}[‡]	V_{CC} = 5.25 V,	V_I = 2.7 V				25	µA
I_{IL}[‡]	V_{CC} = 5.25 V,	V_I = 0.4 V			−80	−250	µA
I_{OS}[§]	V_{CC} = 5.25 V,	V_O = 0.5 V		−30	−70	−130	mA
I_{CC}	V_{CC} = 5.25 V,	V_I = 0,	Outputs open		160	180	mA
C_i	f = 1 MHz,	V_I = 2 V			5		pF
C_o	f = 1 MHz,	V_O = 2 V			6		pF
C_{clk}	f = 1 MHz,	V_{CLK} = 2 V			6		pF

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡] I/O leakage is the worst case of I_{OZL} and I_{IL} or I_{OZH} and I_{IH} respectively.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V_O is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

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TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)		TEST CONDITION	MIN	TYP†	MAX	UNIT
f_{max}‡		without feedback		R1 = 200 Ω, R2 = 390 Ω, See Figure 6	100			MHz
		with internal feedback (counter configuration)			100			
		with external feedback			74			
t_{pd}	I, I/O	O, I/O	1 or 2 outputs switching		3	5.5	7	ns
			8 outputs switching		3	6	7.5	
t_{pd}	CLK↑	Q			2	4	6.5	ns
t_{pd}§	CLK↑	Feedback input					3	ns
t_{en}	OE↓	Q				4	7.5	ns
t_{dis}	OE↑	Q				4	7.5	ns
t_{en}	I, I/O	O, I/O				6	9	ns
t_{dis}	I, I/O	O, I/O				6	9	ns
$t_{sk(o)}$¶	Skew between registered outputs					0.5		ns

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ See section for f_{max} specifications.

§ This parameter applies to TIBPAL16R4' and TIBPAL16R6' only (see Figure 4 for illustration) and is calculated from the measured f_{max} with internal feedback in the counter configuration.

¶ This parameter is the measurement of the difference between the fastest and slowest t_{pd} (CLK-to-Q) observed when multiple registered outputs are switching in the same direction.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) .... 7 V
Input voltage (see Note 1) .... 5.5 V
Voltage applied to disabled output (see Note 1) .... 5.5 V
Operating free-air temperature range .... −55°C to 125°C
Storage temperature range .... −65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		4.5	5	5.5	V
V_{IH}	High-level input voltage		2		5.5	V
V_{IL}	Low-level input voltage				0.8	V
I_{OH}	High-level output current				−2	mA
I_{OL}	Low-level output current				12	mA
f_{clock}†	Clock frequency		0		62.5	MHz
t_w	Pulse duration, clock (see Note 2)	High	8			ns
		Low	8			
t_{su}†	Setup time, input or feedback before clock↑		10			ns
t_h†	Hold time, input or feedback after clock↑		0			ns
T_A	Operating free-air temperature		−55	25	125	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS			MIN	TYP†	MAX	UNIT
V_{IK}		V_{CC} = 4.5 V,	I_I = − 18 mA			−0.8	− 1.5	V
V_{OH}		V_{CC} = 4.5 V,	I_{OH} = − 2 mA		2.4	3.2		V
V_{OL}		V_{CC} = 4.5 V,	I_{OL} = 12 mA			0.3	0.5	V
I_{OZH}‡		V_{CC} = 5.5 V,	V_O = 2.7 V				100	µA
I_{OZL}‡	0, Q outputs	V_{CC} = 5.5 V,	V_O = 0.4 V				−0.1	mA
	I/O ports						− 0.25	
I_I		V_{CC} = 5.5 V,	V_I = 5.5 V				1	mA
I_{IH}	I/O ports	V_{CC} = 5.5 V,	V_I = 2.7 V				100	µA
	All others						25	
I_{IL}‡		V_{CC} = 5.5 V,	V_I = 0.4 V			− 0.08	− 0.25	mA
I_{OS}§		V_{CC} = 5.5 V,	V_O = 0.5 V		−30	−70	− 130	mA
I_{CC}		V_{CC} = 5.5 V,	V_I = GND,	Outputs open		140	200	mA
C_i		f = 1 MHz,	V_I = 2 V				5	pF
C_o		f = 1 MHz,	V_O = 2 V				6	pF
$C_{clk/oe}$		f = 1 MHz,	$V_{CLK/OE}$ = 2 V				6	pF

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ I/O leakage is the worst case of I_{OZL} and I_{IL} or I_{OZH} and I_{IH} respectively.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V_O is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

TIBPAL16L8-10M, TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	TYP†	MAX	UNIT
f_{max}‡	without feedback			62.5			MHz
	with internal feedback (counter configuration)			62.5			
	with external feedback			52.5			
t_{pd}	I, I/O	O, I/O	R1 = 390 Ω,	2	6	10	ns
t_{pd}	CLK↑	Q	R2 = 750 Ω,	1	4	9	ns
t_{pd}§	CLK↑	Feedback input	See Figure 6			5	ns
t_{en}	OE↓	Q		1	4	10	ns
t_{dis}	OE↑	Q		1	4	10	ns
t_{en}	I, I/O	O, I/O		2	6	12	ns
t_{dis}	I, I/O	O, I/O		1	6	10	ns

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ See section for f_{max} specifications. f_{max} with external feedback is not production tested but is calculated from the equation found in the f_{max} section.

§ This parameter applies to TIBPAL16R4' and TIBPAL16R6' only (see Figure 4 for illustration) and is calculated from the measured f_{max} with internal feedback in the counter configuration.

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programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

Step 1.   With V_{CC} at 5 volts and Pin 1 at V_{IL}, raise Pin 11 to V_{IHH}.
Step 2.   Apply either V_{IL} or V_{IH} to the output corresponding to the register to be preloaded.
Step 3.   Pulse Pin 1, clocking in preload data.
Step 4.   Remove output voltage, then lower Pin 11 to V_{IL}. Preload can be verified by observing the voltage level at the output pin.

Figure 1. Preload Waveforms

NOTE 3: $t_d = t_{su} = t_h$ = 100 ns to 1000 ns V_{IHH} = 10.25 V to 10.75 v

power-up reset (see Figure 2)

Following power up, all registers are reset to zero. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.

† This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.
‡ This is the setup time for input or feedback.

Figure 2. Power-Up Reset Waveforms

f_{max} SPECIFICATIONS

f_{max} without feedback, see Figure 3

In this mode, data is presented at the input to the flip-flop and clocked through to the Q output with no feedback. Under this condition, the clock period is limited by the sum of the data setup time and the data hold time ($t_{su} + t_h$). However, the minimum f_{max} is determined by the minimum clock period (t_w high + t_w low).

Thus, f_{max} without feedback $= \dfrac{1}{(t_w high + t_w low)}$ or $\dfrac{1}{(t_{su} + t_h)}$.

Figure 3. f_{max} Without Feedback

f_{max} with internal feedback, see Figure 4

This configuration is most popular in counters and on-chip state-machine designs. The flip-flop inputs are defined by the device inputs and flip-flop outputs. Under this condition, the period is limited by the internal delay from the flip-flop outputs through the internal feedback and logic array to the inputs of the next flip-flop.

Thus, f_{max} with internal feedback $= \dfrac{1}{(t_{su} + t_{pd} CLK - to - FB)}$.

Where tpd CLK-to-FB is the deduced value of the delay from CLK to the input of the logic array.

Figure 4. f_{max} With Internal Feedback

f_{max} SPECIFICATIONS

f_{max} with external feedback, see Figure 5

This configuration is a typical state-machine design with feedback signals sent off-chip. This external feedback could go back to the device inputs or to a second device in a multi-chip state machine. The slowest path defining the period is the sum of the clock-to-output time and the input setup time for the external signals (t_{su} + t_{pd} CLK-to-Q).

Thus, f_{max} with external feedback $= \dfrac{1}{(t_{su} + t_{pd} \text{ CLK}-\text{to}-\text{Q})}.$

Figure 5. f_{max} With External Feedback

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TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16L8-10M, TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS

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PARAMETER MEASUREMENT INFORMATION

**LOAD CIRCUIT FOR
3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en}, 5 pF for t_{dis}.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses have the following characteristics: For C suffix, use the voltage levels indicated in parentheses ( ), PRR ≤ 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%; For M suffix, use the voltage levels indicated in brackets [ ], PRR ≤ 10 MHz, t_r and $t_f ≤ 2$ ns, duty cycle = 50%
 D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
 E. Equivalent loads may be used for testing.

Figure 6. Load Circuit and Voltage Waveforms

TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16L8-10M, TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® CIRCUITS

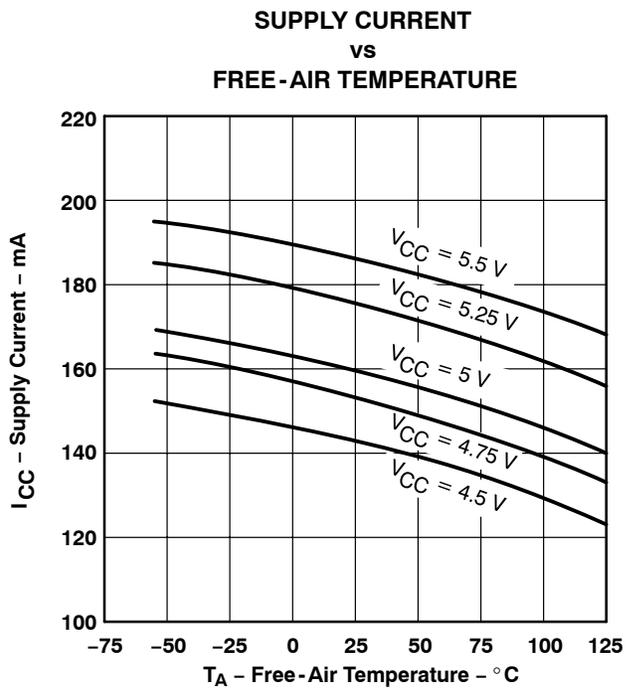SRPS006E – D3115, MAY 1988 – REVISED DECEMBER 2010
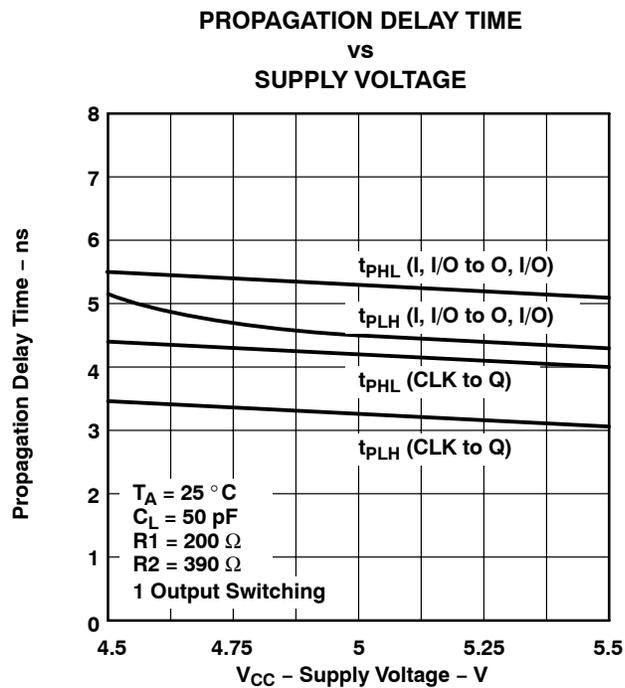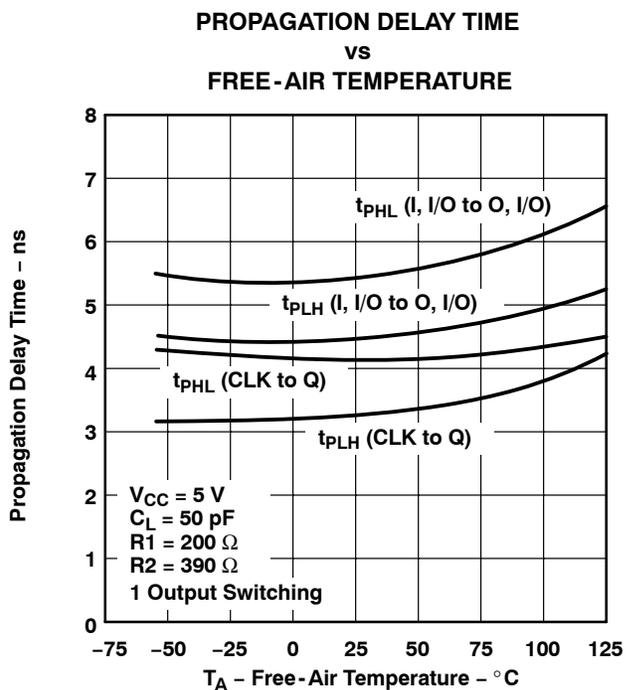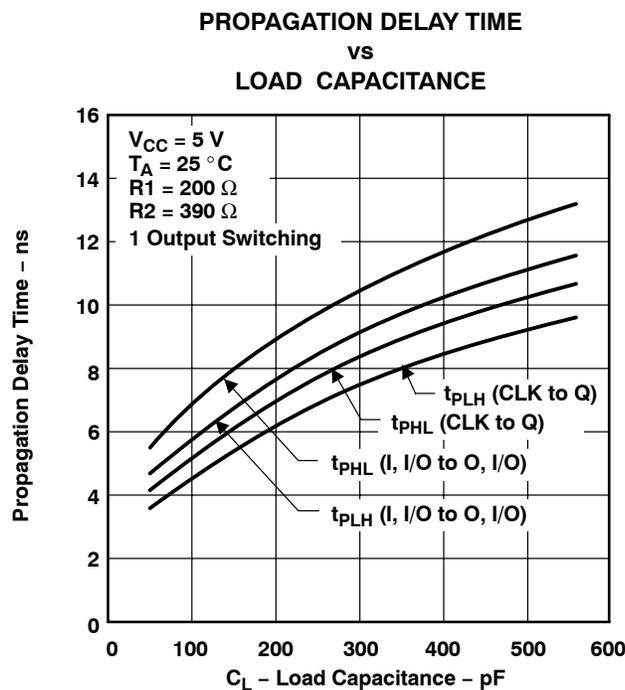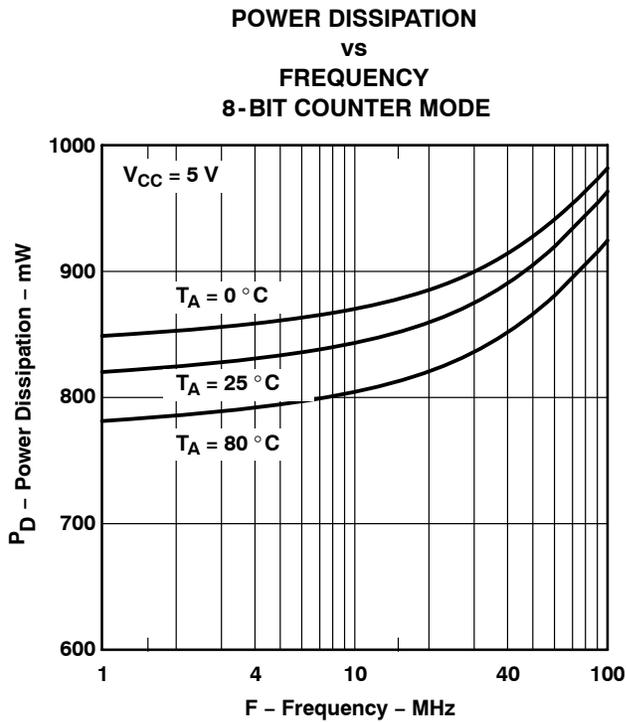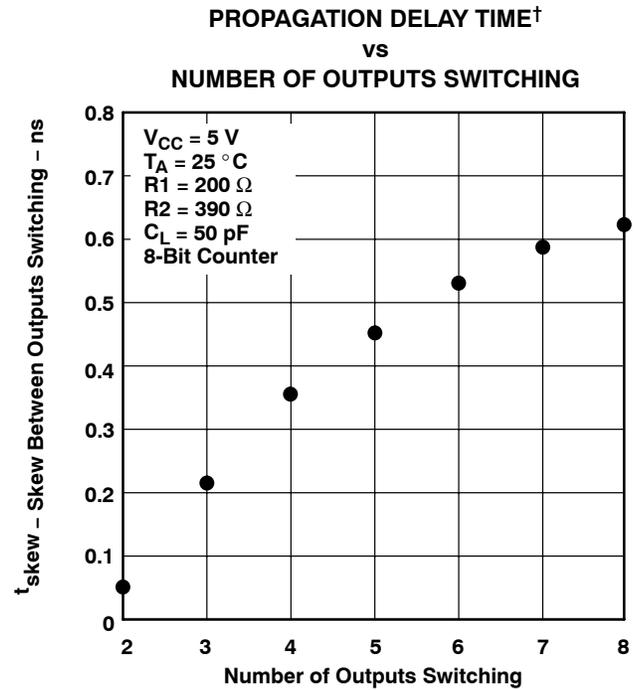
TYPICAL CHARACTERISTICS

SUPPLY CURRENT
vs
FREE-AIR TEMPERATURE

Figure 7

PROPAGATION DELAY TIME
vs
SUPPLY VOLTAGE

Figure 8

PROPAGATION DELAY TIME
vs
FREE-AIR TEMPERATURE

Figure 9

PROPAGATION DELAY TIME
vs
LOAD CAPACITANCE

Figure 10

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

TIBPAL16L8-7C, TIBPAL16R4-7C, TIBPAL16R6-7C, TIBPAL16R8-7C
TIBPAL16L8-10M, TIBPAL16R4-10M, TIBPAL16R6-10M, TIBPAL16R8-10M
HIGH-PERFORMANCE *IMPACT-X* ™ *PAL* ® **CIRCUITS**

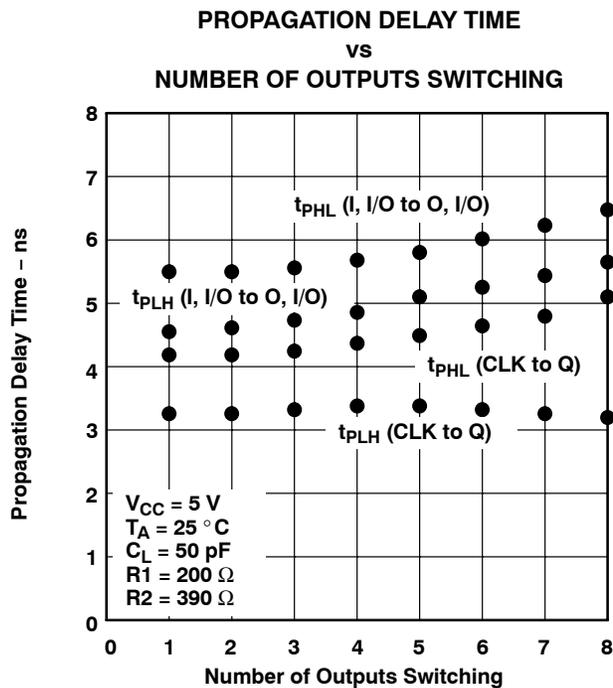SRPS006E – D3115, MAY 1988 – REVISED DECEMBER 2010

TYPICAL CHARACTERISTICS

**POWER DISSIPATION
vs
FREQUENCY
8 - BIT COUNTER MODE**

Figure 11

**PROPAGATION DELAY TIME†
vs
NUMBER OF OUTPUTS SWITCHING**

Figure 12

**PROPAGATION DELAY TIME
vs
NUMBER OF OUTPUTS SWITCHING**

Figure 13

†Outputs switching in the same direction (t_{PLH} compared to t_{PLH}/t_{PHL} to t_{PHL})

TEXAS
INSTRUMENTS

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TEXAS INSTRUMENTS

D0892

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-85155182A	NRND	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-85155182A TIBPAL16 R8-10MFKB	
5962-8515518RA	NRND	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8515518RA TIBPAL16R8-10M JB	
5962-8515518SA	NRND	CFP	W	20	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8515518SA TIBPAL16R8-10M WB	
TIBPAL16R8-10MFKB	NRND	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-85155182A TIBPAL16 R8-10MFKB	
TIBPAL16R8-10MJB	NRND	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8515518RA TIBPAL16R8-10M JB	
TIBPAL16R8-10MWB	NRND	CFP	W	20	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8515518SA TIBPAL16R8-10M WB	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
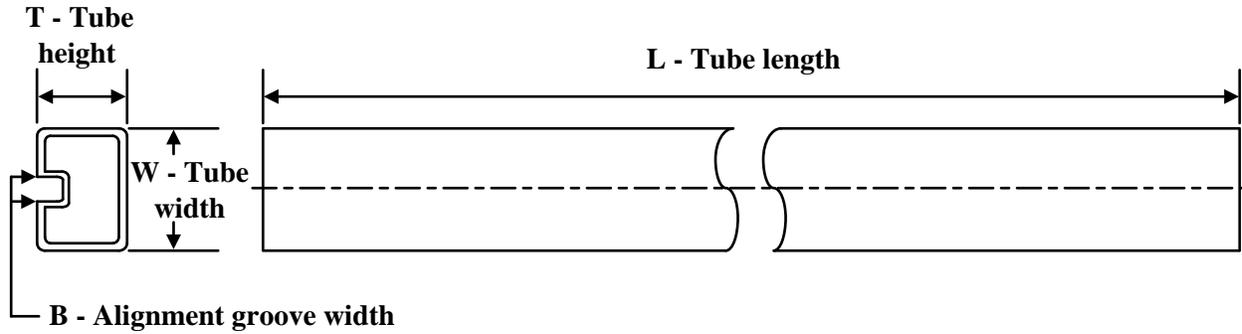
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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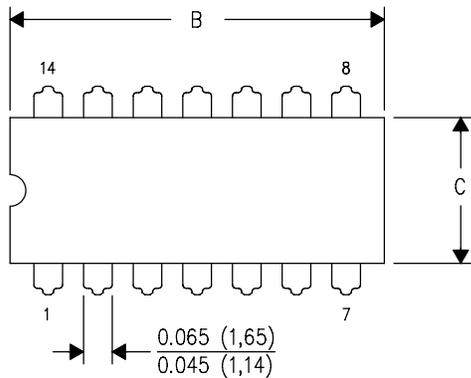
PACKAGE MATERIALS INFORMATION

TUBE

T - Tube height

L - Tube length

W - Tube width

B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-85155182A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8515518SA	W	CFP	20	25	506.98	26.16	6220	NA
TIBPAL16R8-10MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TIBPAL16R8-10MWB	W	CFP	20	25	506.98	26.16	6220	NA

J (R-GDIP-T**)   CERAMIC DUAL IN-LINE PACKAGE
14 LEADS SHOWN

PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

1   7

$\frac{0.065\ (1,65)}{0.045\ (1,14)}$

C

0.005 (0,13) MIN

$\frac{0.060\ (1,52)}{0.015\ (0,38)}$

A

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

$\frac{0.026\ (0,66)}{0.014\ (0,36)}$

0.100 (2,54)

0°-15°

$\frac{0.014\ (0,36)}{0.008\ (0,20)}$

4040083/F 03/03

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package is hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
         E.   Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4229370/A\

W (R−GDFP−F20)   CERAMIC DUAL FLATPACK

0.045 (1,14)
0.026 (0,66)

0.300 (7,62)
0.245 (6,22)

Base and Seating Plane

0.100 (2,45)
0.045 (1,14)

0.009 (0,23)
0.004 (0,10)

0.320 (8,13) MAX

1   20

0.022 (0,56)
0.015 (0,38)

0.540 (13,72) MAX

0.050 (1,27)

0.005 (0,13) MIN
4 Places

10   11

0.370 (9,40)
0.250 (6,35)

0.370 (9,40)
0.250 (6,35)

4040180−4/F   04/14

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. This package can be hermetically sealed with a ceramic lid using glass frit.
        D. Index point is provided on cap for terminal identification only.
        E. Falls within Mil−Std 1835 GDFP2−F20

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